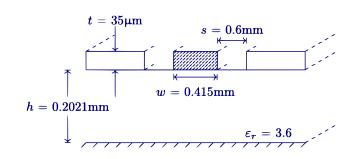


Layer Material	Layer (File) Name	Thickness (mm)	Permittivity	Loss Tangent
 Silkscreen	F.Silk	0.00762		
 Soldermask	F.Mask	0.0254	4.5	0.029
 Copper	F.Cu	0.0432		
FR408HR 2113		0.2021	3.6	0.010
 Copper	In1.Cu	0.0175		
FR408—HR		0.9906	3.64	0.0098
 Copper	In2.Cu	0.0175		
FR408HR 2113		0.2021	3.6	0.010
 Copper	B.Cu	0.0432		
 Soldermask	B.Mask	0.0254	4.5	0.029
 Silkscreen	B.Silk	0.00762		



Hole	pattern	for	Hammond	1554B

Remy		

Sheet: File: PMA3-14LN+.kicad_pcb

Title: 50-10000 MHz SMT LNA

Size: USLetter	Date: 4/12/2024	Rev: A
KiCad E.D.A. po	cbnew 7.0.5	ld: 1/1

